FORM PTO-1595 RE	0 - 2004 T U.S. DEPARTMENT OF COMMERC
To the Honorable Commissioner c 102	390334 attached original documents or copy the
1. Name of conveying party(ies):  (CLUMA DUCUE  (CLUMA DU	Name and address of receiving party(ies):     Name: _ Sony Corporation
KEIJI MABUCHI  Additional name(s) of conveying party(ies) at  ☐ Yes ☒ No	Internal Address: ached? 7-35, Kitashinagawa 6-chome Shinagawa-ku, Tokyo 141, Japan
3. Nature of conveyance:   ☐ Assignment ☐ Merger  ☐ Security Agreement ☐ Change of Na  ☐ Other  Execution Date February 25, 2004	Street Address:  me  City:State:Zip:  Additional Name(s) & Address(es) attached □ Yes ☒
4. Application (number(s) or patent number( If this document is being filed together with a	
A. Patent Application No.(s) U.S. Serial No. 10/684,939 filed Octob Attorney Docket No. 09792909-5698	B: Patent No.(s) er 14, 2003
Additional numbers attached? ☐ Yes 区 N	
5. Name and address of party to whom correspondence concerning document shoul	6. Total number of applications and patents invo
mailed:  SONNENSCHEIN NATH & ROSENTHA P.O. Box #061080 Wacker Drive Station Sears Tower Chicago, IL 60606-1080	7. Total Fee (37 CFR 3.41
Customer ID No. 26263	8. Deposit Account Number:  19.3140  (Attach duplicate copy of this page if paying by deposit accounts)
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9. Statement and signature: To the best of my knowledge and belief, the f a true copy of the original document.	regoing information is true and correct and any attached co
David R. Metzger  Name of Person Signing	Signature March 5, 2004  Total number of pages 2
	over sheet information to: nmissioner for Patents signment Recordation Services
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> PATENT REEL: 015046 FRAME: 0787

Docket Number:	09792909-5698
JOCKEL Mulliper:	

## ASSIGNMENT

WHEREAS, I, as a below named inventor, residing at the address stated next to my name, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in SOLID-STATE IMAGING DEVICE AND CONTROL METHOD FOR SAME

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;

AND WHEREAS, Sony Corporation, a Japanese corporation with offices at 7-35 Kitashinagawa 6-Chome, Shinagawa-Ku, Tokyo, Japan (hereinafter referenced as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in this application to insert the serial number and filing date of this application in the spaces that follow: Serial Number: 10/684,939, Filing Date: 0ct, 14, 2003.

This assignment executed on the dates indicated below.

Name of first or sole inventor

Kanagawa, Japan

Residence of first or sole inventor

Kanabuchi

Signature of first or sole inventor

Date of this assignment

PATENT REEL: 015046 FRAME: 0788

RECORDED: 03/08/2004